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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2662176

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MARIANO LAYSON CHING JR.	02/28/2013
ALLEN M. DESCARTIN	02/28/2013
BO LI	02/28/2013

RECEIVING PARTY DATA

Name:	Freescale Semiconductor, Inc.	
Street Address:	6501 William Cannon Drive West	
Internal Address:	Law Department	
City:	Austin	
State/Country:	TEXAS	
Postal Code:	78735	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14142924	

CORRESPONDENCE DATA

Fax Number: (512)895-6630 Phone: 512-895-6979

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Correspondent Name: **DEE MATOCHA**

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Address Line 4: AUSTIN, TEXAS 78735

ATTORNEY DOCKET NUMBER:	MT11918AK
NAME OF SUBMITTER:	CASSIE YE

PATENT REEL: 031856 FRAME: 0276

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Signature:	/Cassie Ye/
Date:	12/30/2013
Total Attachments: 4 source=MT11918AK-US-20130228-ASSIGI source=MT11918AK-US-20130228-ASSIGI source=MT11918AK-US-20130228-ASSIGI source=MT11918AK-US-20130228-ASSIGI	NMENT#page2.tif NMENT#page3.tif

PATENT REEL: 031856 FRAME: 0277

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, MARIANO LAYSON CHING, JR. AND ALLEN M. DESCARTIN OF THE PHILLIPINES AND BO LI OF THE P.R. OF CHINA, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in LEAD FRAME AND SUBSTRATE SEMICONDUCTOR PACKAGE (Docket No. MT11918AK), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for

PATENT REEL: 031856 FRAME: 0278 the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

MARIANO LAYSON CHENG, JR.	DATE:	FEB-28-2013	_
First Witness Gamy Ge SIGNATURE OF WITNESS	DATE:	「E	-
Garry Ge PRINTED NAME OF WITNESS No.15 Xinghua Avenue Tianjin China PRINTED ADDRESS OF WITNESS			

•		•
Second Witness		
To		
PL Mes	DATE:	Feb-28-2013
SIGNATURE OF WITNESS	DATE	(Month-Day-Year)
		,
Di Mai		
P.L Mei		
PRINTED NAME OF WITNESS		
No 15 Vinghus Augnus Tioniin China		•
No.15 Xinghua Avenue Tianjin China		
PRINTED ADDRESS OF WITNESS		

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ALLEN M. DESCARTIN	DATE: _	Feb - 28 - 2013
<u>First Witness</u>		
Xw Nan. 74ta	DATE: _	Fcb - 28 - 2013. (Month-Day-Year)
Xu Nan PRINTED NAME OF WITNESS		
No.15 Xinghua Avenue Tianjin China PRINTED ADDRESS OF WITNESS		

Second Witness	
Thi Gang Bai (3 5124) DATE:	Feb - 28 - 2013 (Month-Day-Year)
Zhi Gang Bai PRINTED NAME OF WITNESS	
No.15 Xinghua Avenue Tianjin China PRINTED ADDRESS OF WITNESS	

BOLI	DATE: Fob-18-2013
First Witness	
Gamy Ge signature of witness	DATE: Feb -28-2013 (Month-Day-Year)
Garry Ge PRINTED NAME OF WITNESS	
No.15 Xinghua Avenue Tianjin China PRINTED ADDRESS OF WITNESS	

Second Witness		
PL Mei SIGNATURE OF WITNESS	DATE:	Feb - 28 - 20/3 (Month-Day-Year)
P.L Mei PRINTED NAME OF WITNESS		:
No.15 Xinghua Avenue Tianjin China PRINTED ADDRESS OF WITNESS		

RECORDED: 12/30/2013